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November 2013

FDMS015N04B

N-Channel PowerTrench[®] MOSFET 40 V, 100 A, 1.5 m Ω

Features

- $R_{DS(on)}$ = 1.13 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 50 A
- Advanced Package and Silicon Combination for Low R_{DS(on)} and High Efficiency
- · Fast Switching Speed
- · 100% UIL Tested
- · RoHS Compliant

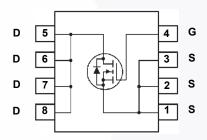
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- · Synchronous Rectification for ATX / Server
- · Battery Protection Circuit
- · Motor Drives and Uninterruptible Power Supplies





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter		FDMS015N04B	Unit
V _{DSS}	Drain to Source Voltage		40	V	
V _{GSS}	Gate to Source Voltage			±20	V
I _D	Drain Current	- Continuous (T _C = 25°C)		100	Α
		- Continuous (T _A = 25°C)	(Note 1a)	31.3	
l _{DM}	Drain Current	- Pulsed	(Note 2)	400	Α
= AS	Single Pulsed Avalanche Energy		(Note 3)	526	mJ
D	Payer Dissipation	$(T_C = 25^{\circ}C)$		104	W
PD	Power Dissipation	$(T_A = 25^{\circ}C)$	(Note 1a)	2.5	W
T _J , T _{STG}	Operating and Storage Temperat	ure Range		-55 to +150	οС

Thermal Characteristics

Symbol	Parameter	FDMS015N04B	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max. (Note 1a)	50	- 6/77

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS015N04B	FDMS015N04B	Power 56	13 "	12 mm	3000 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0 \text{V}$	40	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C	-	37	-	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 32 V, V _{GS} = 0 V	-	-	1	μΑ
I_{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu\text{A}$	2.0	-	4.0	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$	-	1.13	1.5	mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 50 A	-	171	-	S

Dynamic Characteristics

Input Capacitance	V _{DS} = 20 V, V _{GS} = 0 V	-	6560	8725	pF
Output Capacitance		-	2795	3720	pF
Reverse Transfer Capacitance		-	162	-	pF
Energy Releted Output Capacitance	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	3896	-	pF
Total Gate Charge at 10V		-\	91	118	nC
Gate to Source Gate Charge	$V_{DS} = 20 \text{ V}, I_{D} = 50 \text{ A}$	-	26	-	nC
Gate Charge Threshold to Plateau	V _{GS} = 0 V to 10 V	-	9	-	nC
Gate to Drain "Miller" Charge	(Note 4)	-	16	-	nC
Equivalent Series Resistance	f = 1 MHz	-	1.4	-	Ω
	Output Capacitance Reverse Transfer Capacitance Energy Releted Output Capacitance Total Gate Charge at 10V Gate to Source Gate Charge Gate Charge Threshold to Plateau Gate to Drain "Miller" Charge	Output Capacitance $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ f = 1 MHz Reverse Transfer Capacitance $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ f = 1 MHz Total Gate Charge at 10V Gate to Source Gate Charge $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ Gate Charge Threshold to Plateau $V_{DS} = 20 \text{ V}, V_{DS} = 50 \text{ A}$ V $V_{DS} = 20 \text{ V}, V_{DS} = 20 \text{ V}$ V $V_{DS} = 20 \text{ V}$ V	Output Capacitance $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ F = 1 MHz $-$ Reverse Transfer Capacitance $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ $-$ Total Gate Charge at 10V $-$ Gate to Source Gate Charge $V_{DS} = 20 \text{ V}, V_{DS} = 20 \text{ V}$ $-$ Gate Charge $V_{DS} = 20 \text{ V}, V_{DS} = 20 \text{ V}$ $-$ Gate to Drain "Miller" Charge $V_{CS} = 0 \text{ V}$ $-$ (Note 4) $-$	Output Capacitance $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ Reverse Transfer Capacitance $I_{ES} = 1 \text{ MHz}$ $I_$	Output Capacitance $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ $= 1 \text{ MHz}$

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	34	78	ns
t _r		$V_{DD} = 20 \text{ V}, I_{D} = 50 \text{ A}$	-	24	58	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$	-	71	152	ns
t _f	Turn-Off Fall Time	(Note 4)	-/	26	62	ns

Drain-Source Diode Characteristics

I _S	Maximum Continuous Drain to Source Diod	Maximum Continuous Drain to Source Diode Forward Current			100	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Fo	Maximum Pulsed Drain to Source Diode Forward Current			400	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 50 A	-	-	1.3	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 50 A	-	78	/	ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100 A/\mu s$	-	90	-	nC

Notes

TAR_{9JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{9JC} is guaranteed by design while R_{9CA} is determined by the user's board design.



a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper.



 b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

 $^{{\}bf 2.} \ {\bf Repetitive} \ {\bf rating:} \ {\bf pulse-width} \ {\bf limited} \ {\bf by} \ {\bf maximum} \ {\bf junction} \ {\bf temperature}.$

^{3.} L = 3 mH, I_{AS} = 18.72 A, starting T_{J} = 25°C.

^{4.} Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

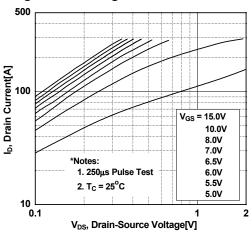


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

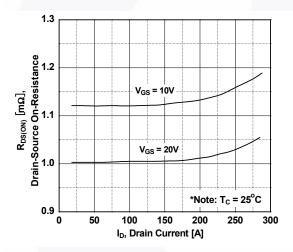


Figure 5. Capacitance Characteristics

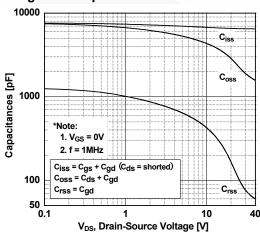


Figure 2. Transfer Characteristics

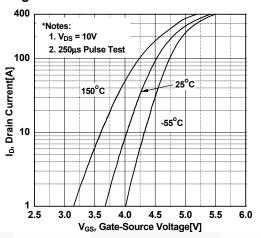


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

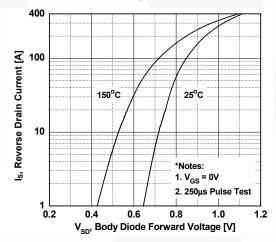
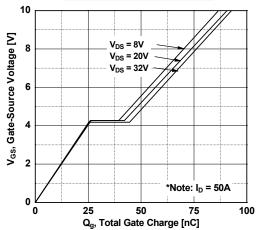


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

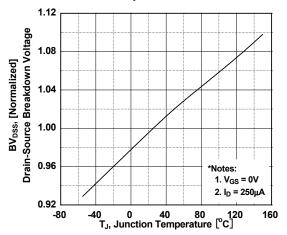


Figure 9. Maximum Safe Operating Area

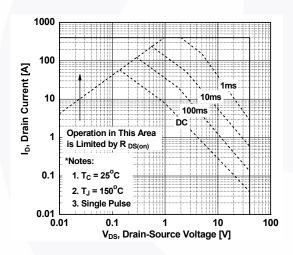


Figure 11. Eoss vs. Drain to Source Voltage

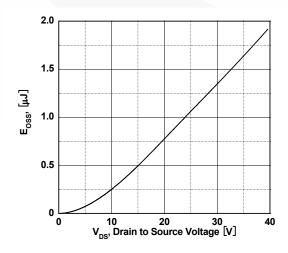


Figure 8. On-Resistance Variation vs. Temperature

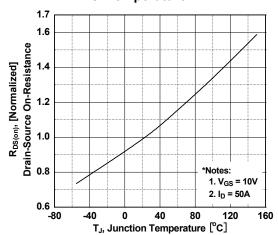


Figure 10. Maximum Drain Current vs. Case Temperature

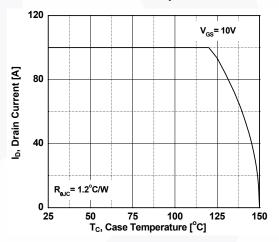
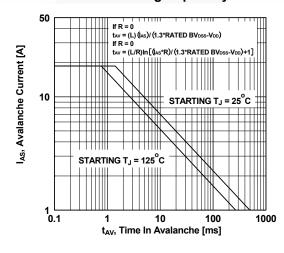


Figure 12. Unclamped Inductive Switching Capability



Typical Performance Characteristics (Continued)

Figure 13. Transient Thermal Response Curve

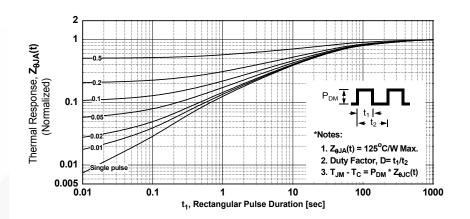


Figure 14. Gate Charge Test Circuit & Waveform

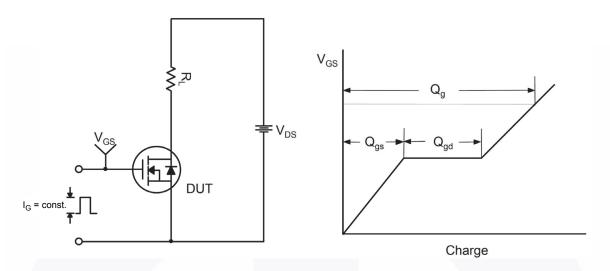


Figure 15. Resistive Switching Test Circuit & Waveforms

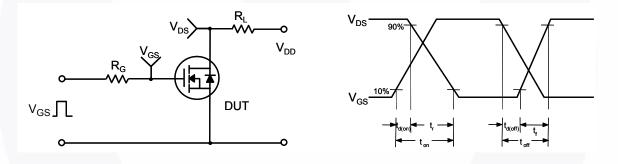
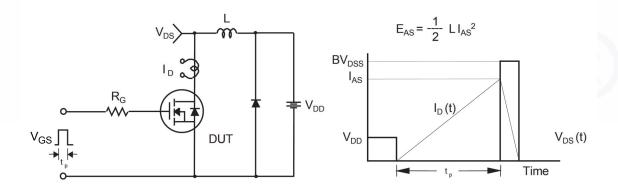


Figure 16. Unclamped Inductive Switching Test Circuit & Waveforms



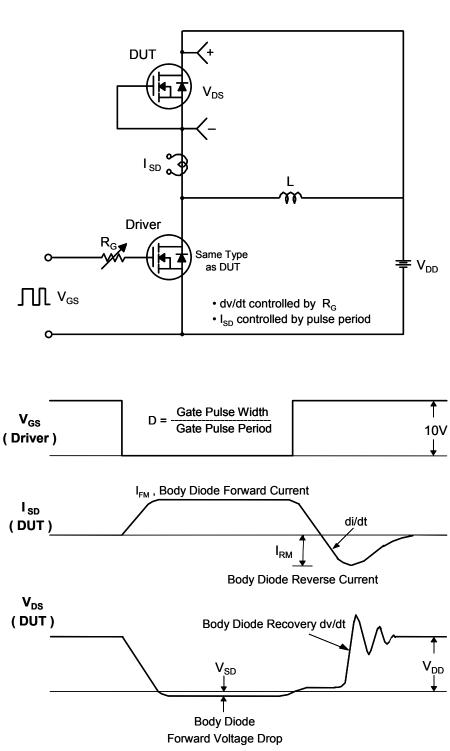


Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms



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